

RECIPIENT

SPECIFICATIONS

PRODUCT

No.: X1E000341006100

MODEL : FA-238A

SPEC. No. : A22-127-1B

DATE: Jul. 14. 2022

SEIKO EPSON CORPORATION

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SPECIFICATIONS

1. Application

- 1) This document is applicable to the crystal FA-238A that are delivered to from Seiko Epson Corp.
- 2) This product complies with RoHS Directive.
- 3) This Product supplied (and any technical information furnished, if any) by Seiko Epson Corporation shall not be used for the development and manufacture of weapon of mass destruction or for other military purposes.
Making available such products and technology to any third party who may use such products or technologies for the said purposes are also prohibited.
- 4) This product listed here is designed as components or parts for electronics equipment in general consumer use.
We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an systems, and medical equipment, the functional purpose of which is to keep extra high reliability, such as satellite, rocket and other space life.
- 5) This product conforms to automotive part standard " AEC-Q200 ".

This FA-238A is authorized for use of ICC-ECU(In Cavin Camera Driver-Electronic Control Unit) for automobile only.

2. Product No. / Model

The product No. of this crystal unit is X1E000341006100
The model is FA-238A.

3. Packing

It is subject to the packing standard of Seiko Epson Corp.

4. Warranty

Defective parts which originate with us are replaced free of charge in the case of defects being found with 12 months after delivery.

5. Amendment and/or termination

Amendment and/or termination of this specification is subject to the agreement between the two parties.

6. Contents

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[1] Absolute maximum ratings

| No. | Item | Symbol | Rating value | | | Unit | Note |
|-----|---------------------------|--------|--------------|------|-------|------|--|
| | | | Min. | Typ. | Max. | | |
| 1 | Storage temperature range | T_stg | - 40 | | + 125 | °C | Depends on the Environmental characteristics specifications. |

[2] Operating range

| No. | Item | Symbol | Rating value | | | Unit | Note |
|-----|-----------------------------|--------|--------------|------|------|------|------|
| | | | Min. | Typ. | Max. | | |
| 1 | Operating temperature range | T_use | -40 | | +125 | °C | |
| 2 | Level of drive | DL | 1 | 100 | 200 | μW | |

[3] Static characteristics

| No. | Item | Symbol | Value | Unit | Conditions |
|-----|---------------------------------------|--------|----------|--------------------------|--|
| 1 | Nominal Frequency | f_nom | 20 | MHz | Fundamental |
| 2 | Frequency tolerance | f_tol | ±30 | × 10 ⁻⁶ | CL = 10 pF Ta = +25 ±3 °C DL : 100 μW Not include aging |
| 3 | Motional resistance | R1 | 60 | Ω | π circuit IEC 60444-2 Ta = Operating temperature range DL : 100 μW |
| 4 | Shunt capacitance | C0 | 5 Max. | pF | π circuit and N.A. |
| 5 | Frequency temperature characteristics | f_tem | ±50 | × 10 ⁻⁶ | Ta = Operating temperature range (Ref. at Ta = +25 °C ±3 °C) DL : 100 μW |
| 6 | Unwanted responses | RS/R1 | 6 Min. | dB | f_nom ±10 % |
| 7 | Isolation resistance | IR | 500 Min. | MΩ | DC 100 V, 60 seconds between each terminals (#1, #3) |
| 8 | Frequency Aging | f_age | ±5 Max. | × 10 ⁻⁶ /year | Ta = +25 °C ±3 °C (first year, no bias) |

[4] Environmental and mechanical characteristics

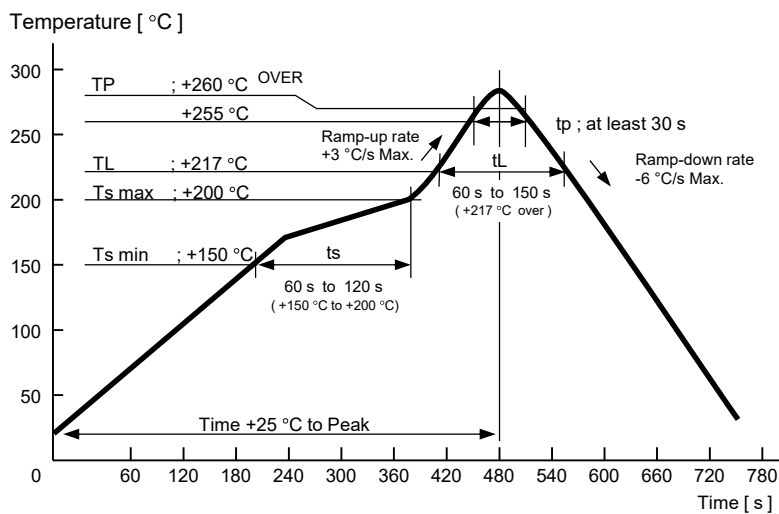
(The company evaluation condition : We evaluate it by the following examination item and examination condition.)

| No. | Item | Value * 1 * 2 | | Test Conditions |
|-----|------------------------------|---|-----------------------------------|--|
| | | * 3 | $\Delta f / f [1 \times 10^{-6}]$ | |
| 1 | Shock | * 3 | ± 5 | 100 g dummy Jig (Epson Standard) drop from 1 500 mm height on the Concrete 3 directions 10 times |
| 2 | Vibration | * 3 | ± 5 | 10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ² 10 Hz → 500 Hz → 10 Hz 15 min./cycle 6 h (2 hours , 3 directions) |
| 3 | High temperature storage | * 3 | ± 10 | +125 °C × 1 000 h |
| 4 | Low temperature storage | * 3 | ± 5 | - 40 °C × 1 000 h |
| 5 | Temperature cycle | * 3 | ± 10 | - 40 °C ↔ +125 °C 30 minutes at each temp. 1 000 cycle |
| 6 | Temperature humidity storage | * 3 | ± 5 | +85 °C × 85 %RH × 1 000 h |
| 7 | Resistance to soldering heat | | ± 5 | For convention reflow soldering furnace (3 times) |
| 8 | Substrate bending | No peeling-off at a soldered part | | Bend width reaches 3.0 mm and hold for 20 s ± 1 s × 1 time Ref. IEC 60068-2-21 |
| 9 | Shear | No peeling-off at a soldered part | | 10 N press for 10 s ± 1 s Ref. IEC 60068-2-21 |
| 10 | Pull – off | No peeling-off at a soldered part | | 10 N press for 10 s ± 1 s Ref. IEC 60068-2-21 |
| 11 | Solderability | Terminals must be 95 % covered with fresh solder. | | Dip termination into solder bath at +235 °C ± 5 °C for 5 s (Using Rosin Flux) |

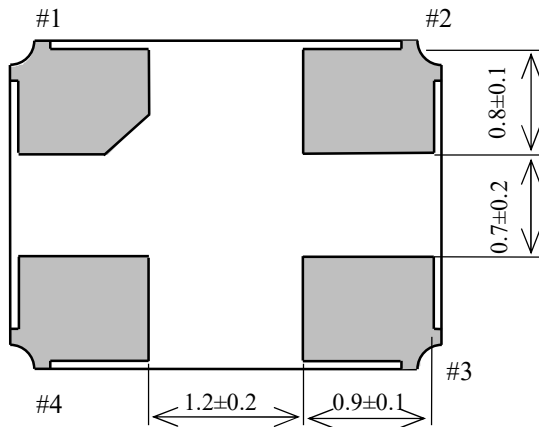
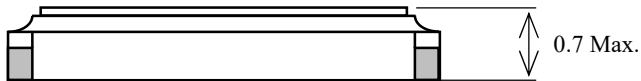
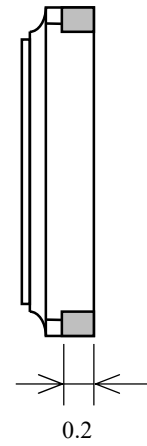
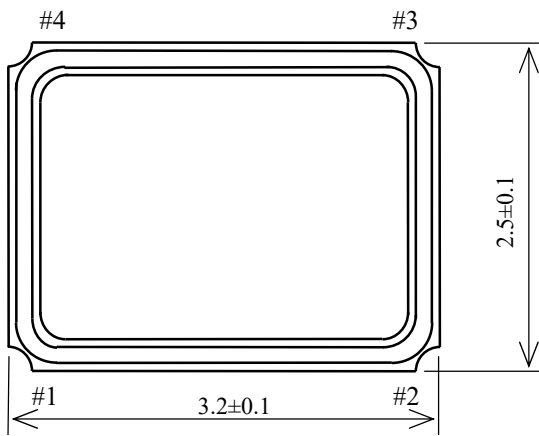
< Notes >

1. * 1 Each test done independently.
2. * 2 Measuring 2 h to 24 h later leaving in room temperature after each test.
3. * 3 Item No.1 to No.6 shall be tested after following pre conditioning.
Measuring 24 h later leaving in room temperature after Pre conditioning.
Pre conditioning : Reflow 3 times.
4. Item No.1 to No.7, Shift motional resistance at after above tests should be less than 20 % or less than 10 Ω.

◆ Reflow condition (follow to IPC/JEDEC J-STD-020D.1)

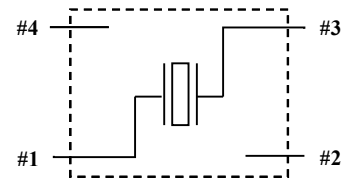


[5] Dimensions and Circuit
Dimension (Unit : mm)



Internal Connection

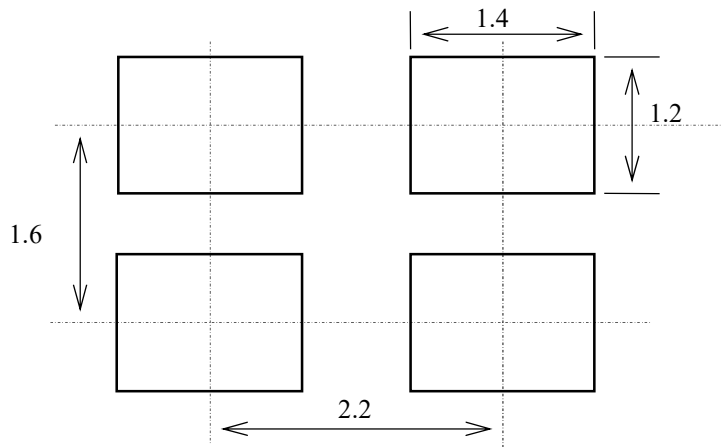
(TOP VIEW)



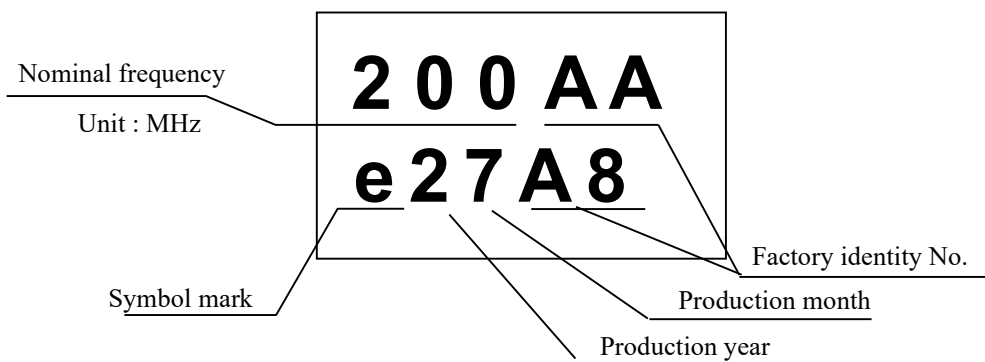
Terminal #2, #4 are connected to the LID
(Please connect GND)
Terminal Plating : Au plating (1.5 μ m Max.)

[6] Recommended soldering pattern and Marking layout

1) Recommended soldering pattern



2) Marking layout



Production month

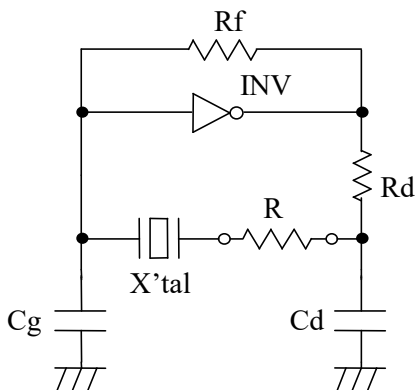
| | | | | | |
|---------|----------|-------|---------|----------|----------|
| January | February | | October | November | December |
| 1 | 2 | | X | Y | Z |

- Nominal frequency is only one example.
- Nominal frequency omits the figure below the first place of decimals.
ex) 20.0 MHz [200]
- The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.

[7] Notes

1. Max three (3) times re-flow is allowed. Its recommended to manually solder when not enough/no solder detected.
(Using soldering iron at +350 °C Max × within 5 seconds)
2. Too much exciting shock or vibration may cause deterioration on damage.
The product may damage depends on the condition such as a shock in assembly machinery.
Please check your process condition in advance to minimize and maintain the shock level.
3. It is recommended to do patterning to the oscillator as short as possible. Abnormal oscillation may happened if the line is too long.
4. Please normal temperature (+15 °C to +35 °C) and normal humidity (25 to 85 %RH) as much as possible for the frequency accuracy securing.
Storing the crystal products under higher or lower temperature or high humidity for long period may affect frequency stability or solderability. Check conditions prior to use.
5. This product may be affected to ultrasonic cleaning.. Check conditions prior to use.
6. When do the be dewy of the oscillation circuit board, the frequency change or the oscillation stop is generated.
Please use it under the condition without the be dewy.
7. Few data or readings taken at user side may be different from our company's data.
Confirmation of the different value is necessary before application.
8. To avoid malfunction, no pattern across or near the crystal is allowed.
9. Start up time of oscillation may be increased or no oscillation may occur unless adequate negative resistance is allocated in the oscillation circuit In order to avoid this, please provide enough negative resistance to the circuit design.

How to check the negative resistance



(1) Connect the resistor(R) to the circuit in series with the crystal unit.

(2) Adjust R so that oscillation can start (or stop).

(3) Measure R when oscillation just start (or stop) in above (2).

* Get the negative resistance

$$-R = R + \text{Motional resistance (R1)}$$

* Recommended -R

$$[-R] > R1 \times 10$$

TAPING SPECIFICATION

テープ梱包基準書

1. APPLICATION 適用範囲

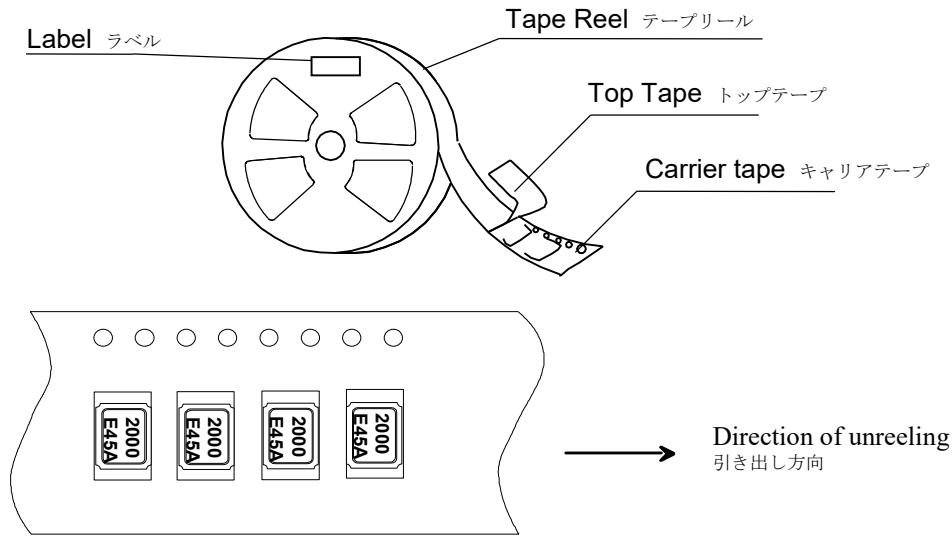
This document is applicable to FA-238A/FA-238VA

本基準書は、FA-238A / FA-238VA のテーピング梱包について規定する。

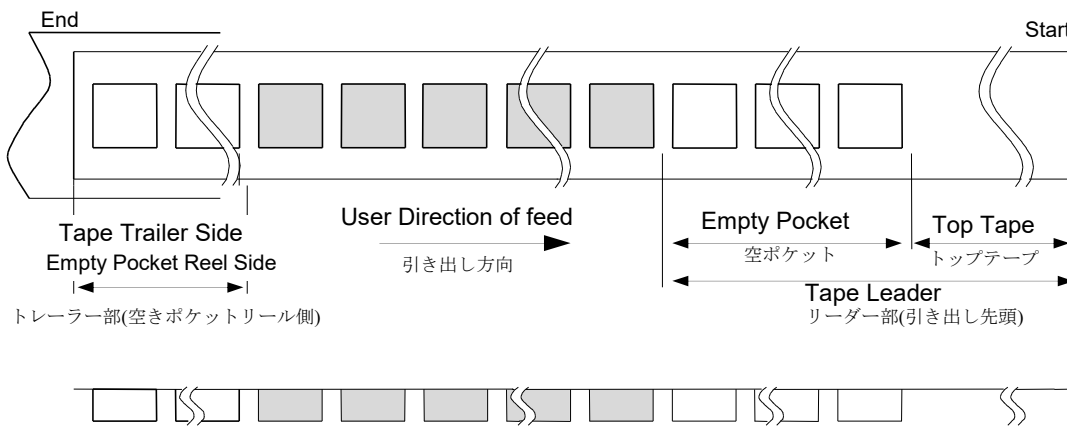
2. CONTENTS 目次

| Item No. 項目 No. | Item 項目 | Page ページ |
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| [3] | Marking 表示 | |
| [4] | Quantity 収納数量 | 4 |
| [5] | Storage environment 保管環境 | |
| [6] | Handling リール取扱い | |

(3) Packing 収納形態
 (a) Tape & Reel デバイス収納方法



(b) Start & End Point 引き出し先頭側及びリール側の処理



| Item 項目 | | Empty Space 空きスペース | Note 備考 |
|--------------------------------------|-------------------------|-----------------------|---|
| Tape Leader テープ リーダー (引き出し先頭側) | Top Tape トップテープ | Min. 1 000 mm | Feeding in the Top tape, the tip is fixed with tape. トップテープ単独で繰り出し、先端はテープにより固定。 Winding method is a diagram of the above リールへの巻き取り方法は、上図の通り。 |
| | Carrier Tape キャリアテープ | Min. 100 mm | |
| Tape Trailer テープ トレーラー (リール側) | Top Tape | Min. 0 mm | Tip is fixed to the reel. 先端はリールに固定。 |
| | Carrier Tape | Min. 160 mm | |

(4) Peel force of the cover tape トップテープの剥離強度

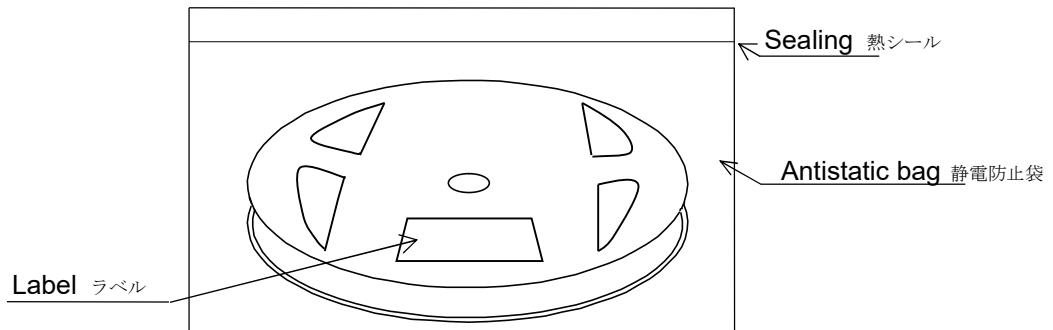
(a) angle : cover tape during peel off and the direction of unreeling shall be 165° to 180°.
 剥離角度: テープの接着面に対し 165~180 度とする。

(b) peel speed : 300 mm/min
 剥離速度: 300 mm/min とする。

(c) peel strength : 0.1~1.0 N
 剥離強度: 0.1~1.0 N

[2] Shipping Carton 外装箱への収納

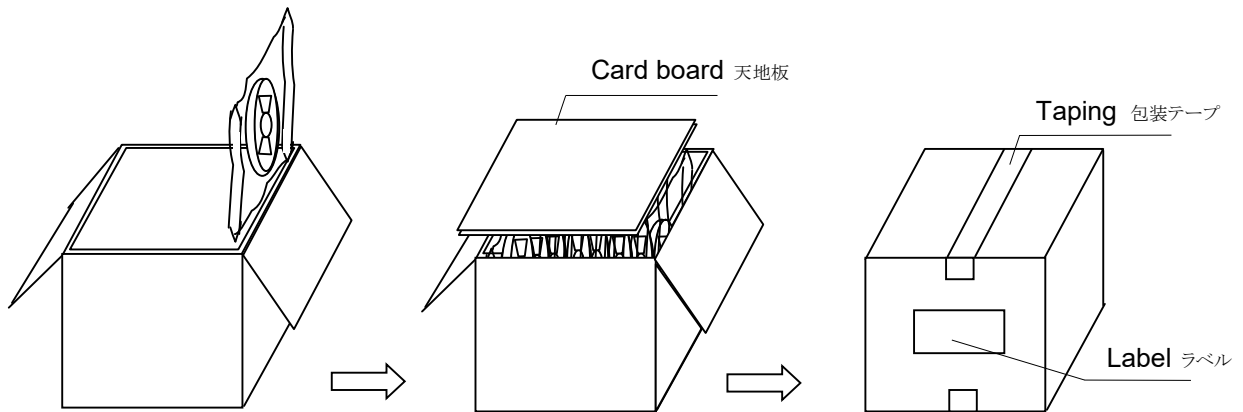
a) Packing to antistatic bag 袋への収納



b) Packing to shipping carton 外装箱への収納

If there is space in the outer box, material is put in a shock absorbing together.

空間ができた時は、クッション材を入れる。



[3] Marking 表示

(1) Reel marking リールへの表示

● Reel marking shall consist of

下記内容をリール表面に表示できるラベルを貼る。:

- 1) Parts name 製品名称
- 2) Quantity 製品数量
- 3) Manufacturing Date or symbol 製品の製造年月又はこれを示す記号
- 4) Manufacturer's Name or symbol 製品の製造業者又はその略号
- 5) Others (if necessary) その他必要事項

(2) Shipping carton marking 外装箱への表示

● Shipping carton marking shall consist of :

下記内容を外装箱表面に表示できるラベルを貼る。:

- 1) Parts name 製品名称
- 2) Quantity 製品数量

[4] Quantity 収納数量

- 4 000 pcs./reel (Standard)

However it is not the limit, in case that the order quantity does not fill with 4000 pieces.
Packing quantity is defined by 14th and 15th digit of product number.

但し、注文数量が 4 000 pcs に満たない場合は、その限りではない。
収納数量は、製品型番の 14 桁、15 桁による。

| 14th and 15th digit of product number. 製品型番の 14 桁、15 桁 | Quantity 数量 |
|---|-----------------------------|
| 00 | 4 000 pcs |
| 01 | Vinyl Bag(Bulk) ビニール袋 (バルク) |
| 11 | Any Quantity 任意の数量 |
| 12 | 250 pcs |
| 13 | 500 pcs |
| 14 | 1 000 pcs |
| 15 | 2 000 pcs |
| 16 | 3 000 pcs |

[5] Storage environment 保管環境

- (1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.

開梱前の製品は、温度 +30 °C、湿度 85 %RH 以下での保管をして下さい。
貴社納入後、袋未開封で 6 ヶ月以内の実装を推奨します。

- (2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.

使用直前まで開梱せず、袋開封後は 6 ヶ月以内の実装を推奨します。
温度 +30 °C、湿度 85 %RH 以下では、はんだ付け作業前に乾燥不要です。

- (3) Not to storage with some erosive chemicals.

化学薬品類との同居を避ける。

- (4) Nothing is allowed to put on the reel or carton to prevent mechanical damage

外装箱がゆがまないようまた、外圧がかからないように保管して下さい。

[6] Handling リール取扱い

To handle with care to prevent the damage of tape, reel and products.

リールの取扱いについては、中のテープ・製品を変形させないようにして下さい。

- PROCESS QUALITY CONTROL -

No.A-1302-01-AAE-2

SMD TYPE AT STRIP CRYSTAL FA-238A

2015.02.23

FA238A_Q_0001

| Manufacturing process chart | No. | Section | Standards | Inspection,Control Items | Inspection Methods | Instrument | Record |
|--|-----------------------------|--|--|---|--|--|------------------------------------|
| <p style="text-align: center;">CRYSTAL BLOCK</p> | 1 | Inspection Section | Purchasing Specification Incoming Inspection Standard | Dimension Outer Appearance Inner Appearance | Sampling " " | Length Gauge Visual Inspection Visual Inspection | In-Coming Inspection Data Sheet |
| | 1 | Inspection Section | " | Dimension Outer Appearance | Sampling " | Comparator Microscope | " |
| | 2 | Production Section | Manufacturing Instruction Sheet | Cut Angle Wafer Thickness | Sampling " | X-ray Radio Grafic Comparator | Process Data Sheet |
| | 3 | Production Section | " | Frequency Wafer Thickness | Sampling " | Blank Osillator Comparator | " |
| | 4 | Production Section | " | Dimension | Sampling | Comparator | " |
| | 5 | Production Section | " | Frequency Outer Appearance | Sampling " | Blank Osillator Microscope | " |
| | 6 | Production Section | " | Frequency Outer Appearance | Sampling " | Blank Osillator Microscope | " |
| | 7 | Production Section | " | Outer Appearance | 100% Inspection | Microscope | " |
| | 8 | Production Section | " | Frequency | Sampling | Network Analyzer | " |
| | 9 | Production Section | " | Outer Appearance | 100% Inspection | Microscope | " |
| | 10 | Production Section | " | Package Leak | 100% Inspection | Leak Tester | " |
| | 11 | Production Section | " | Outer Appearance | Sampling | Microscope | " |
| | 12 | Production Section | " | Crystal Impedance Frequency Insulation Resistance Temp. Characteristic Outer Appearance | 100% Inspection " " Sampling 100% Inspection | Inspection M/C " " " Microscope | " |
| | 13 | Inspection Section | Out-going Inspection Standard | Crystal Impedance Frequency Insulation Resistance Outer Appearance | Sampling " " " | Inspection M/C " " Microscope | Out-going Inspection Data Sheet |
| | 14 | Production Section | Manufacturing Instruction Sheet | Tape-Peel Strength | Sampling | Peeling Force Tester | Process Data Sheet |
| 15 | Production Controle Section | Manufacturing Instruction Sheet Packing Instruction Sheet | Destination Quantity | - | - | Delivery Slip | |

Structure Diagram 構造図

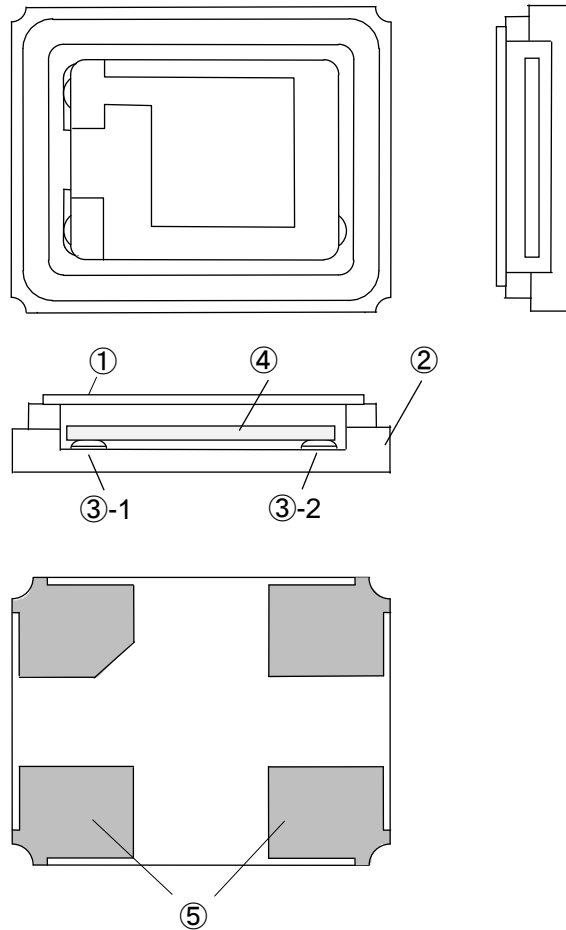
Rev.02

Model
型式

FA-238A

Document No.
管理No.

FA238A_D_0001



| No. | Name of Part 部品名 | Remarks 備考 |
|-----|-------------------------|---|
| ① | Lid リッド | |
| ② | Package パッケージ | |
| ③ | Crystal adhesive 接着剤 | Over 27 MHz (2 Point Bonding) 27MHz 超える周波数は 2 点固定 |
| ④ | Crystal chip 水晶片 | |
| ⑤ | Terminal 端子 | |

RELIABILITY TEST DATA

Product Name : FA-238A

The Company evaluation condition

We evaluate environmental and mechanical characteristics by the following test condition .

No. DTA-1314-1

| No. | ITEM | TEST CONDITIONS | VALUE *1 *2 | TEST | FAIL |
|-----|------------------------------|--|--|--------------|--------------|
| | | | $\Delta F/F$ [1×10^{-6}] | Qty [n] | Qty [n] |
| 1 | Drop | 100g dummy Jig (Epsontoyocom Standard) drop from 1500 mm height on the Concrete 3 directions 10 times | *3 ± 5 | 22 | 0 |
| 2 | Vibration | 10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ² 10 Hz 500 Hz 10 Hz 15 min./cycle 6 h (2 hours , 3 directions) | *3 ± 5 | 22 | 0 |
| 3 | High temperature storage | +125 °C × 1 000 h | *3 ± 10 | 22 | 0 |
| 4 | Low temperature storage | -40 °C × 1 000 h | *3 ± 5 | 22 | 0 |
| 5 | Temperature cycle | -40 °C + 125 °C 30 min at each temp. 1000 cycles | *3 ± 10 | 22 | 0 |
| 6 | Temperature humidity storage | +85 °C × 85 %RH × 1 000 h | *3 ± 5 | 22 | 0 |
| 7 | Resistance to soldering heat | For convention reflow soldering furnace (3 times) | ± 5 | 22 | 0 |
| 8 | Substrate bending | Bend width reaches 3.0 mm and hold for 20 s ± 1 s × 1 time Ref. IEC 60068-2-21 | No peeling-off at a soldered part | 11 | 0 |
| 9 | Shear | 10 N press for 10 s ± 1 s Ref. IEC 60068-2-21 | No peeling-off at a soldered part | 11 | 0 |
| 10 | Pull – off | 10 N press for 10 s ± 1 s Ref. IEC 60068-2-21 | No peeling-off at a soldered part | 11 | 0 |
| 11 | Solderability | Dip termination into solder bath at +230°C ± 10 °C for 5 s (Using Rosin Flux) | Termination must be 95 % covered with fresh solder | 11 | 0 |

Notes

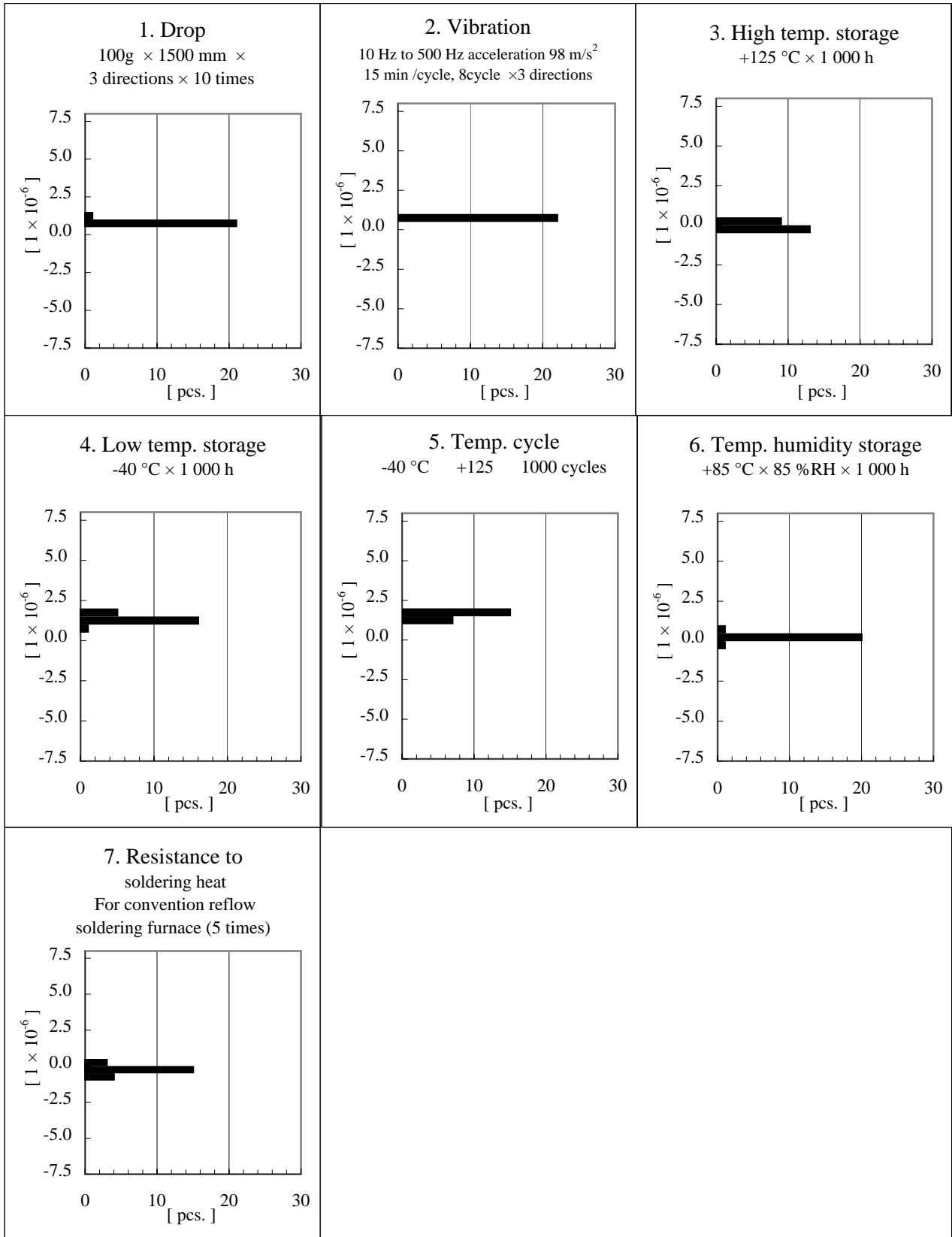
- *1 Each test done independently.
- *2 measuring 24 h later leaving in room temperature after each test.
- *3 Item No.1 to No.6 shall be tested after following pre conditioning.
Measuring 24 h later leaving in room temperature after Pre conditioning.
Pre conditioning : Reflow 3 times.
- Item No.1 to No.7, Shift motional resistance at after above tests should be less than 20 % or less than 10 .

Qualification Data

Product Name : FA-238A

$\Delta f / f$

No. DTA-1314-2



Product Name : FA-238A

Δ CI

No. DTA-1314-3

